

DM74LS00 Quad 2-Input NAND Gates

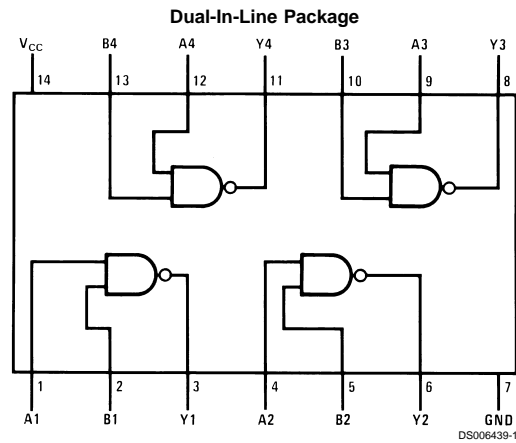
General Description

This device contains four independent gates each of which performs the logic NAND function.

Features

- Alternate Military/Aerospace device (54LS00) is available. Contact a Fairchild Semiconductor Sales Office/Distributor for specifications.

Connection Diagram



Order Number 54LS00DMQB, 54LS00FMQB, 54LS00LMQB, DM54LS00J, DM54LS00W, DM74LS00M or DM74LS00N
See Package Number E20A, J14A, M14A, N14A or W14B

Function Table

$$Y = \overline{AB}$$

Inputs		Output
A	B	Y
L	L	H
L	H	H
H	L	H
H	H	L

H = High Logic Level
L = Low Logic Level

Absolute Maximum Ratings (Note 1)

Supply Voltage	7V	DM54LS and 54LS	-55°C to +125°C
Input Voltage	7V	DM74LS	0°C to +70°C
Operating Free Air Temperature Range		Storage Temperature Range	-65°C to +150°C

Recommended Operating Conditions

Symbol	Parameter	DM54LS00			DM74LS00			Units
		Min	Nom	Max	Min	Nom	Max	
V _{CC}	Supply Voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High Level Input Voltage	2			2			V
V _{IL}	Low Level Input Voltage			0.7			0.8	V
I _{OH}	High Level Output Current			-0.4			-0.4	mA
I _{OL}	Low Level Output Current			4			8	mA
T _A	Free Air Operating Temperature	-55		125	0		70	°C

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 2)	Max	Units
V _I	Input Clamp Voltage	V _{CC} = Min, I _I = -18 mA			-1.5	V
V _{OH}	High Level Output Voltage	V _{CC} = Min, I _{OH} = Max, V _{IL} = Max	DM54 2.5	3.4		V
V _{OL}	Low Level Output Voltage	V _{CC} = Min, I _{OL} = Max, V _{IH} = Min	DM54 0.25	0.35	0.4	V
		I _{OL} = 4 mA, V _{CC} = Min	DM74 0.25		0.5	
I _I	Input Current @ Max Input Voltage	V _{CC} = Max, V _I = 7V			0.1	mA
I _{IH}	High Level Input Current	V _{CC} = Max, V _I = 2.7V			20	µA
I _{IL}	Low Level Input Current	V _{CC} = Max, V _I = 0.4V			-0.36	mA
I _{OS}	Short Circuit Output Current	V _{CC} = Max	DM54 -20		-100	mA
		(Note 3)	DM74 -20		-100	
I _{CCH}	Supply Current with Outputs High	V _{CC} = Max		0.8	1.6	mA
I _{CCL}	Supply Current with Outputs Low	V _{CC} = Max		2.4	4.4	mA

Switching Characteristics

at V_{CC} = 5V and T_A = 25°C

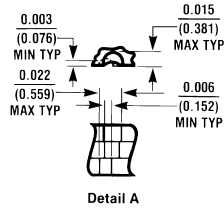
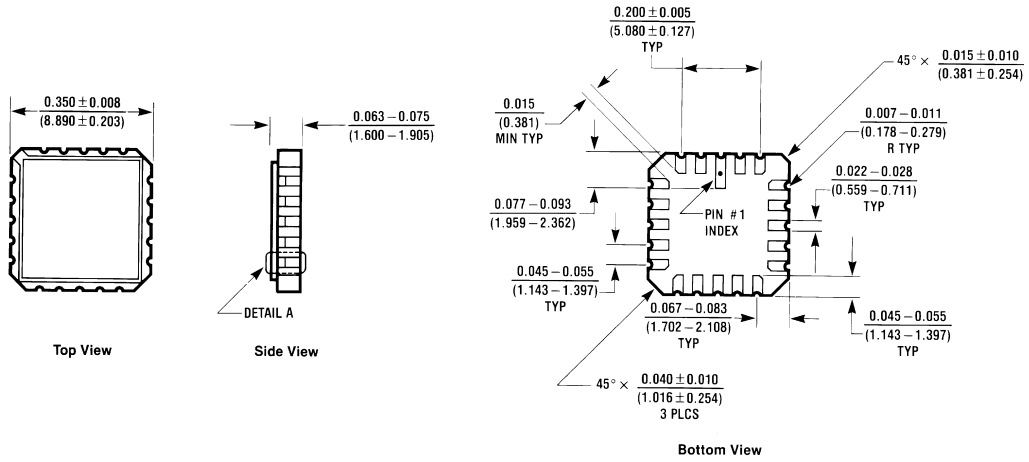
Symbol	Parameter	R _L = 2 kΩ				Units
		C _L = 15 pF		C _L = 50 pF		
		Min	Max	Min	Max	
t _{PLH}	Propagation Delay Time Low to High Level Output	3	10	4	15	ns
t _{PHL}	Propagation Delay Time High to Low Level Output	3	10	4	15	ns

Note 2: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 3: Not more than one output should be shorted at a time, and the duration should not exceed one second.

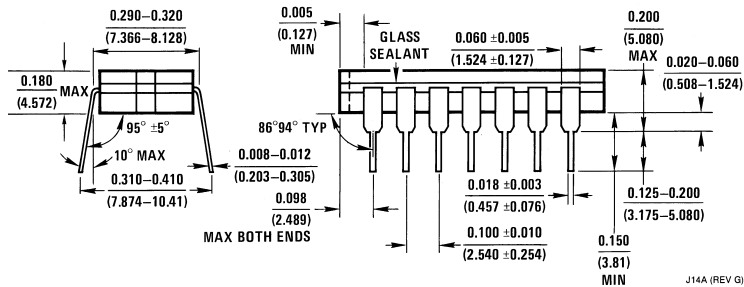
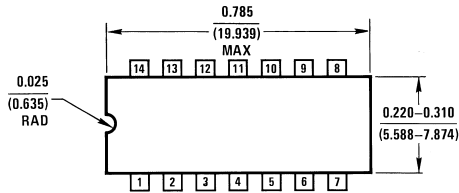


Physical Dimensions inches (millimeters) unless otherwise noted



Ceramic Leadless Chip Carrier Package (E)
 Order Number 54LS00LMQB
 Package Number E20A

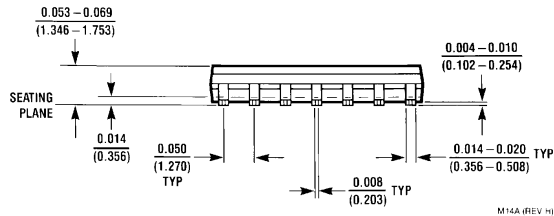
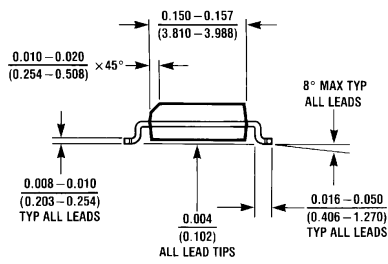
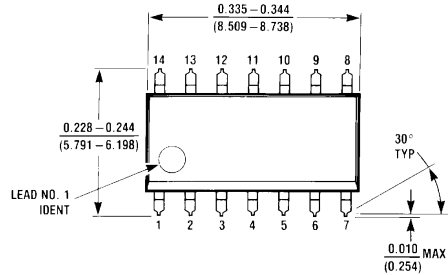
E20A (REV D)



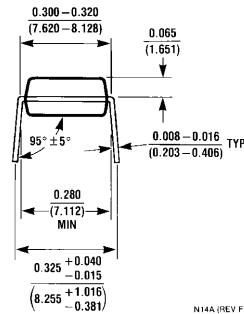
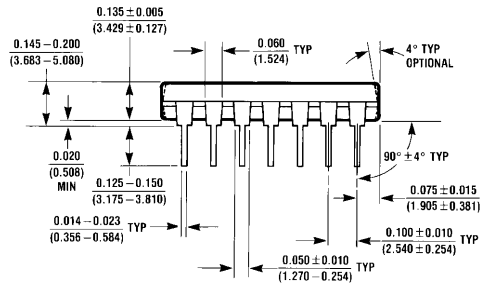
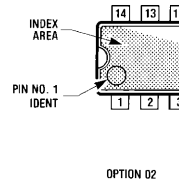
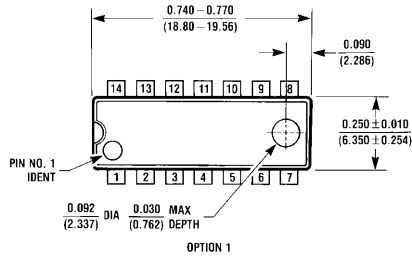
14-Lead Ceramic Dual-In-Line Package (J)
 Order Number 54LS00DMQB or DM54LS00J
 Package Number J14A

J14A (REV G)

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

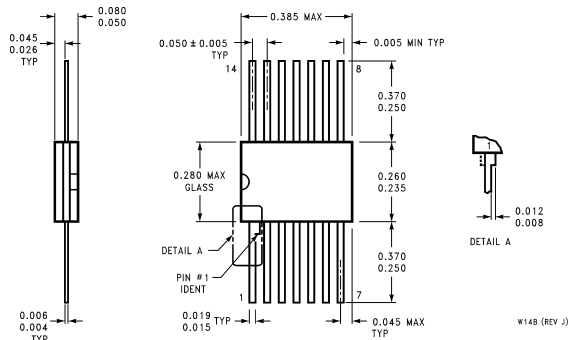


14-Lead Small Outline Molded Package (M)
Order Number DM74LS00M
Package Number M14A



14-Lead Molded Dual-In-Line Package (N)
Order Number DM74LS00N
Package Number N14A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



14-Lead Ceramic Flat Package (W)
Order Number 54LS00FMB or DM54LS00W
Package Number W14B

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